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**TYSiC**

**Guangdong Tianyu Semiconductor Co., Ltd.**

**廣東天域半導體股份有限公司**

(the “Company”)

*(A joint stock company incorporated in the People’s Republic of China with limited liability)*

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*This announcement is made by the order of the Company. The Company’s board of directors (the “**Board**”) collectively and individually accept responsibility for the accuracy of this announcement.*



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This announcement is made by the Company pursuant to Rule 12.01C of the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong Limited (the “**Listing Rules**”).

As of the date of this announcement, the Company has appointed the following overall coordinators:

**Sponsor-Overall Coordinator**

CLSA Limited

**Overall Coordinators**

China International Capital Corporation Hong Kong Securities Limited

CMB International Capital Limited

GF Securities (Hong Kong) Brokerage Limited

*(in alphabetical order)*

Further announcement(s) shall be made by the Company in accordance with the Listing Rules in the event of further appointment or termination of overall coordinator(s) by the Company.

By order of the Board

**Guangdong Tianyu Semiconductor Co., Ltd.**

**Li Xiguang**

*Chairman and executive director*

Hong Kong, July 22, 2025

*The directors of the Company named in the application to which this announcement relates are: (i) Mr. LI Xiguang as executive director; (ii) Mr. AU YEUNG Chung, and Mr. JIANG Dacai as non-executive directors; and (iii) Mr. HE Zhengsheng, Ms. LI Min, and Mr. CHIN Vincent as independent non-executive directors.*